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User Guide to the JLCPCB Impedance Calculator

The [JLCPCB Impedance Calculator](#) computes track width values and recommended stack-ups from user-input values target impedance, conductor spacing (for edge-coupled pairs), and conductor-to-ground gap (coplanar waveguides).

User Interface

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Layers4

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PCB Thickness1.6

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Inner Copper Weight0.5oz

4
Outer Copper Weight

Impedance Configure

+ New Impedance

Du

6 Impedance (Ω)	7 Type	8 Signal Layer	9 Top Ref	10 Bottom Ref	11 Tra
50	Single Ended (Non coplanar)	L1	/	L2	/
50	Coplanar Single Ended	L1	/	L2	/
100	Coplanar Differential Pair	L1	/	L2	/

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JLC04161H-7628(Standard)

JLC04161H-3313

JLC04161H-3313A(Special)

JLC04161H-7628B(Special)

JL

Impedance (Ω)	Type	Signal Layer	Top Ref	Bottom Ref	Tra
50	Single Ended (Non coplanar)	L1	/	L2	1
50	Coplanar Single Ended	L1	/	L2	1
100	Coplanar Differential Pair	L1	/	L2	8

Layer	Material	Thickness (mil)
L1	Outer Copper Weight1oz	1.38
Prepreg	7628, RC 49%, 8.6 mil	8.28
L2	Inner Copper Weight	0.60
Core	1.1mm H/HOZ with copper	41.93
L3	Inner Copper Weight	0.60
Prepreg	7628, RC 49%, 8.6 mil	8.28
L4	Outer Copper Weight1oz	1.38

1. **Layers**: Total number of copper layers in the board.
2. **Finished Thickness**: Thickness of the finished PCB, including soldermask.
3. **Internal Copper Thickness**: Copper weight for internal layers. The calculator only supports 0.5 oz and 1 oz; for cal contact customer support.
4. **External Copper Thickness**: Copper weight for the top and bottom layers. Although JLCPCB can produce boards supports 1 oz because (1) the wider tolerance of 2 oz traces hinders impedance control, and (2) most signal traces on
5. **Unit**: Options are mm, mil, μm, and inch.
6. **Impedance (Ω)**: The desired impedance. The range of accepted values is 20 to 90 Ω for single-ended and 50 to 15
7. **Type**: Options are microstrip (single-ended), coplanar (single-ended), edge-coupled (differential), and dual coplanar selected before changing this option.
8. **Layer**: Which layer the signal should be on.
9. **Reference Layer Above**: Only needed if the signal is on an internal layer.
10. **Reference Layer Below**: Does not need to be one layer below the signal; for example for a signal on L3, this opti ground plane associated with the signal on the reference layer selected.
11. **Conductor Spacing**: The gap between the two conductors in a differential trace. Increasing conductor spacing inc
12. **Conductor-to-Ground Gap**: The gap between the signal conductor and the surrounding ground in a coplanar wa

Notes

- The first stack-up recommended by the calculator usually has the lowest cost and quickest turn-around.
- The 3313 prepreg replaces the previously available 2313. Their thickness and dielectric constant (ε_r) are the same.
- For the same nominal copper weight, internal layers have a slightly smaller thickness than external layers due to a si during deoxidation etc. For example, 0.5 oz copper on internal layers is 15.2 μm thick 4- to 8-layinstead of the nomina

· Results for 4- to 8-layer boards are calculated assuming Nan Ya Plastics NP-155F core material, and SYTECH S10C correct material should be selected when ordering so that the calculated parameters give accurate impedances.

Calculation Parameters Used

External copper thickness (1 oz)	1.6 mil
Internal copper thickness (0.5 oz)	0.6 mil
Internal copper thickness (1 oz)	1.2 mil
Base soldermask thickness	1.2 mil
Copper-surface soldermask thickness	0.6 mil
Soldermask thickness in between traces	1.2 mil
Soldermask dielectric constant (εr)	3.8
Trace top width	Trace base width – 1 mil

Nan Ya Plastics NP-155F (4 to 8 layers)

Core Thickness	εr	Prepreg Type	Resin Content	Nominal Thickness	εr
0.08 mm	3.99	7628	49%	8.6 mil	4.4
0.10 mm	4.36	3313 (2313)	57%	4.2 mil	4.1
0.13 mm	4.17	1080	67%	3.3 mil	3.91
0.15 mm	4.36	2116	54%	4.9 mil	4.16
0.20 mm	4.36				
0.25 mm	4.23				
0.30 mm	4.41				
0.35 mm	4.36				
0.40 mm	4.36				
0.45 mm	4.36				
0.50 mm	4.48				
0.55 mm	4.41				
0.60 mm	4.36				
0.65 mm	4.36				
0.70 mm	4.53				
> 0.70 mm	4.43				

SYTECH (Shengyi) S1000-2M (10+ layers)

Core Thickness	εr	Prepreg Type	Resin Content	Nominal Thickness	εr
0.075 mm	4.14	106	72%	1.97 mil	3.92
0.10 mm	4.11	1080	69%	3.31 mil	3.99
0.13 mm	4.03	2313	58%	4.09 mil	4.31
0.15 mm	4.35	2116	57%	5.00 mil	4.29
0.20 mm	4.42				
0.25 mm	4.29				
0.30 mm	4.56				

The values provided above are for reference only. Some of the values have been calculated from test results by JLCPCB

Stack-Up Naming Scheme

Board thickness

Int. Cu

JLC04161H-7628

Layer count

Ext. Cu

Prepreg type

Last updated on Aug 25, 2023

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👎 No

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